

Customer View Model

3D\_IGS.ZIP

English

Customer View Model

3D\_STP.ZIP

English

Product Environmental Compliance

TE Material Declaration

MD\_1554116-2\_05192017057\_dmtec

PDF

English

FEATURES



Please review product documents or [contact us](#) for the latest agency approval information.

Please Note: Use the Product Drawing for all design activity.

Product Type Features

Product Type Socket

Configuration Features

Number of Positions 1356

Grid Spacing 1.016 x 1.016 mm [ .04 x .04 in ]

Body Features

Plating Thickness (µin) 15

Plating Material Gold

Frame Style Square

Contact Features

Socket Type LGA 1356-2

Contact Mating Area Plating Material Gold

Contact Mating Area Plating Thickness 15

Contact Base Material Copper Alloy

Mechanical Attachment

PCB Mounting Style Surface Mount - Solder Ball

Heat Sink Attachment Without

Housing Features

Housing Color Black

Housing Material High Temperature Thermoplastic

Industry Standards

UL Flammability Rating UL 94V-0

Packaging Features

**Packaging Method** Tray

**Tray Color** Black

Other

**Comment** Lead-Free Solderball

**PRODUCT COMPLIANCE**



Statement of Compliance

**Statement of Compliance**

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